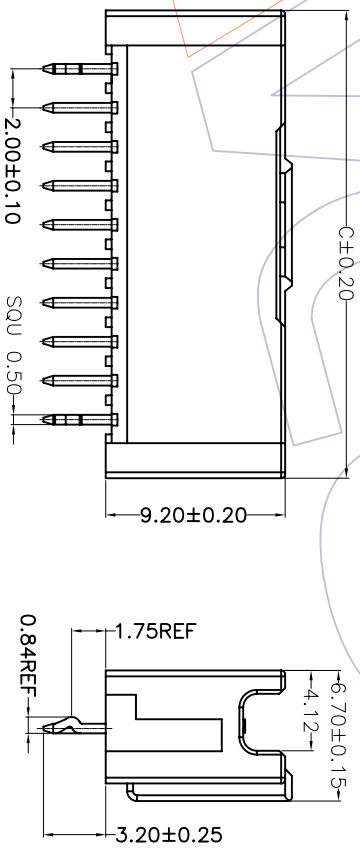
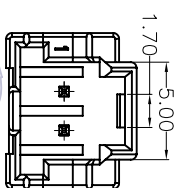
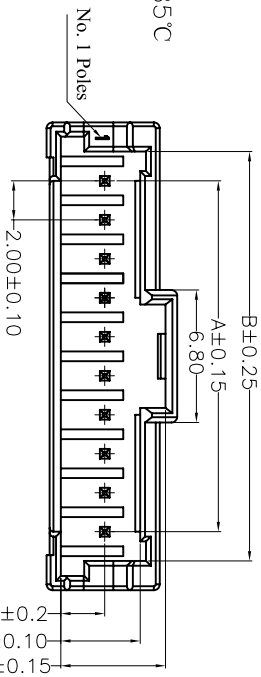


# HSF

**NOTES:**

Current Rating: 1.0AMP  
 Voltage Rating: 250V AC/DC  
 Contact Resistance: 30mΩ Max  
 Withstand Voltage: 800V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -25°C to +85°C  
 Contact Material: Brass  
 Contact plating: Sn over Ni  
 Insulator Material: PBT(W/O G.F)



## Ordering Information

WF2007-WS XX W 0 1

No. of Pins    Colour    Packing  
 02P~15P    W=White    0=PE Bag

## Dimensional & Ordering Information

Circuit	Part No.	Dimension			Q'ty /Bag
		A	B	C	
02	WF2007-WS02W01	2.0	5.0	8.0	1,000
03	WF2007-WS03W01	4.0	7.0	10.0	1,000
04	WF2007-WS04W01	6.0	9.0	12.0	500
05	WF2007-WS05W01	8.0	11.0	14.0	500
06	WF2007-WS06W01	10.0	13.0	16.0	400
07	WF2007-WS07W01	12.0	15.0	18.0	400
08	WF2007-WS08W01	14.0	17.0	20.0	400
09	WF2007-WS09W01	16.0	19.0	22.0	250
10	WF2007-WS10W01	18.0	21.0	24.0	250
11	WF2007-WS11W01	20.0	23.0	26.0	250
12	WF2007-WS12W01	22.0	25.0	28.0	250
13	WF2007-WS13W01	24.0	27.0	30.0	200
14	WF2007-WS14W01	26.0	29.0	32.0	200
15	WF2007-WS15W01	28.0	31.0	34.0	200



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)

**WCON** 维峰五金电子有限公司  
 WAVE HARDWARE ELECTRONICS CO. LTD

PART NO.    SBB TAB  
 TITLE:    MX2.0 Wafer 180° DIP  
 Customer NO.

OPERATION		DRAW		SCALE	
X.X	±0.40	WEIXD	08/08/05	2.5:1	
X.XX	±0.25	DESIGN		UNIT	mm
X.XXX	±0.15	CHECK		SIZE	A4
Angle	± 3'	APPROVE		SHEET	1/1
DIM	TOL	PROJ.			Customer NO.

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE
A0	08/08/05	NEW		
1				